

NeuroNexus is pleased to announce a new H-series package. This "hybrid" package is comprised of an A-Style silicon probe, a polymer cable, and an application specific connector assembly.

The H-series replaces the NeuroNexus F-series package which utilized a commercial flex circuit as the cable. Optimized assembly techniques, along with the increased flexibility of the new microfabricated cable, offer a superior package for your chronic implants. This H-series is designed to interface with our new head-mounted microdrive, providing a means to periodically move your implanted NeuroNexus array after implantation.

In addition, the H-series package can be used as an alternative to the current Cstyle chronic assembly, which includes a silicon probe with integrated silicon cable. The H-series offers unprecedented modularity, providing you the opportunity to choose any A-Style probe for your chronic experiment. The H-Series polymer interconnect also offers improved robustness and flexibility.

Like most NeuroNexus products, a custom design service is available for those customers who have specific requirements not met with catalog devices.

Close Up View of the "Hybrid" Interface



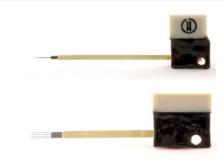
Cable Specifications

Substrate Material	Polyimide
Number of channels	16, 32 or 64
Length	16/32: 21mm
	64: 30mm

Thickness

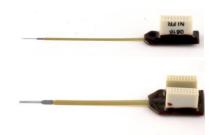
15µm

NEURONEXUS TECHNOLOGIES

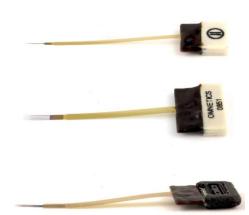


Available Packaging Options

HP16 / HP32 Package Optimized for narrower implant footprint



HC16 / HC32 Package Package with percutaneous connectors



H16 / H32 / HZ64 Package F-Series replacement. Intended for use with microdrive systems.

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